

# Single N-channel MOSFET

## ELM52326BSA-S

<http://www.elm-tech.com>

### ■General description

ELM52326BSA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate threshold voltage.

### ■Features

- $V_{ds}=150V$
- $I_d=2.5A$
- $R_{ds(on)} = 350m\Omega$  ( $V_{gs}=10V$ )
- $R_{ds(on)} = 400m\Omega$  ( $V_{gs}=4.5V$ )

### ■Maximum absolute ratings

$T_a=25^{\circ}C$ . Unless otherwise noted.

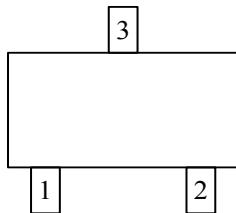
| Parameter                                      | Symbol    | Limit       | Unit        |
|--|-----------|-------------|-------------|
| Drain-source voltage                           | $V_{ds}$  | 150         | V           |
| Gate-source voltage                            | $V_{gs}$  | $\pm 20$    | V           |
| Continuous drain current( $T_j=150^{\circ}C$ ) | $I_d$     | 2.5         | A           |
| $T_a=70^{\circ}C$                              |           | 1.5         |             |
| Pulsed drain current                           | $I_{dm}$  | 6           | A           |
| Power dissipation                              | $P_d$     | 2.0         | W           |
| $T_c=70^{\circ}C$                              |           | 1.3         |             |
| Operating junction temperature                 | $T_j$     | 150         | $^{\circ}C$ |
| Storage temperature range                      | $T_{stg}$ | - 55 to 150 | $^{\circ}C$ |

### ■Thermal characteristics

| Parameter                              | Symbol          | Typ. | Max. | Unit          |
|--|-----------------|------|------|---------------|
| Thermal resistance junction-to-ambient | $R_{\theta ja}$ |      | 120  | $^{\circ}C/W$ |

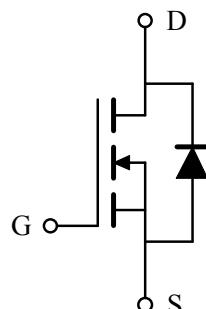
### ■Pin configuration

SOT-23(TOP VIEW)



| Pin No. | Pin name |
|---------|----------|
| 1       | GATE     |
| 2       | SOURCE   |
| 3       | DRAIN    |

### ■Circuit



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### ■Electrical characteristics

Ta=25°C. Unless otherwise noted.

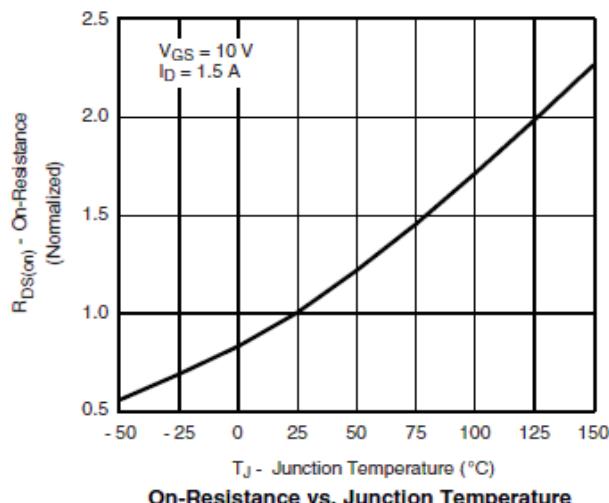
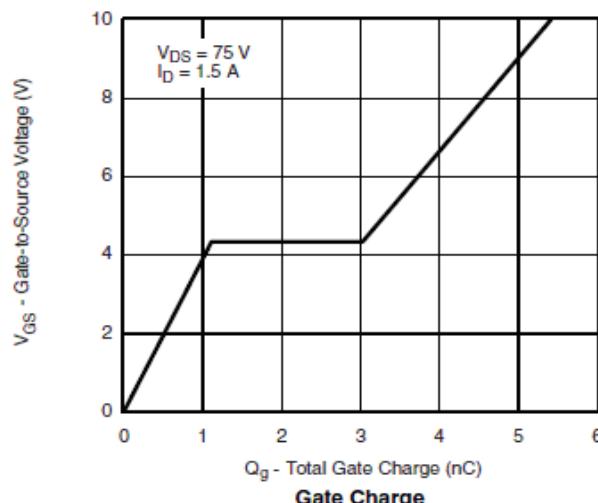
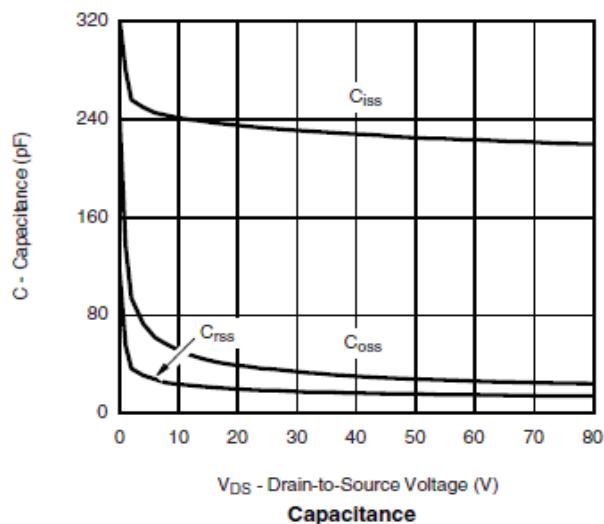
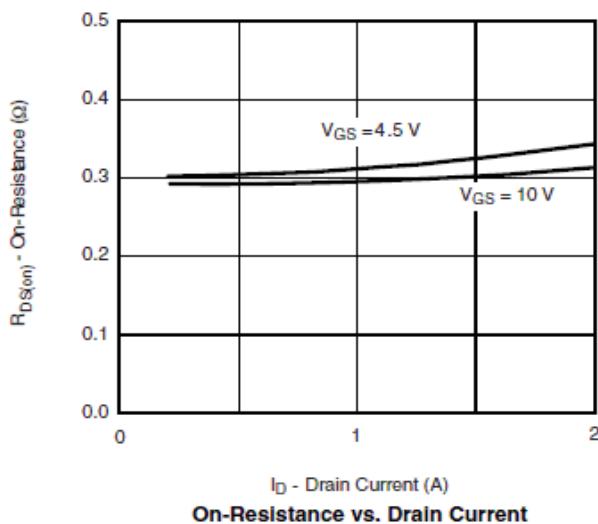
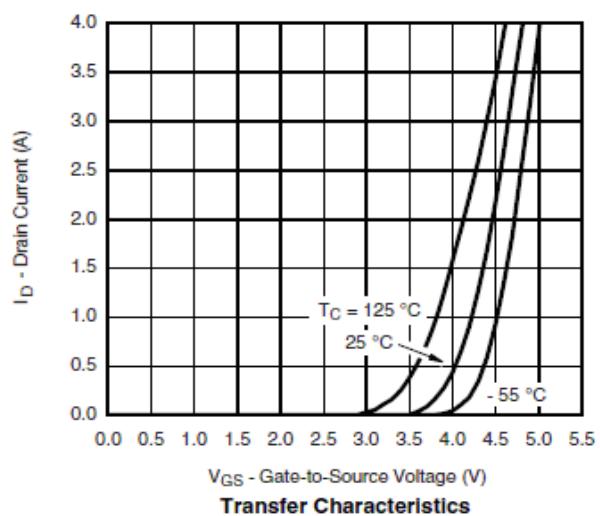
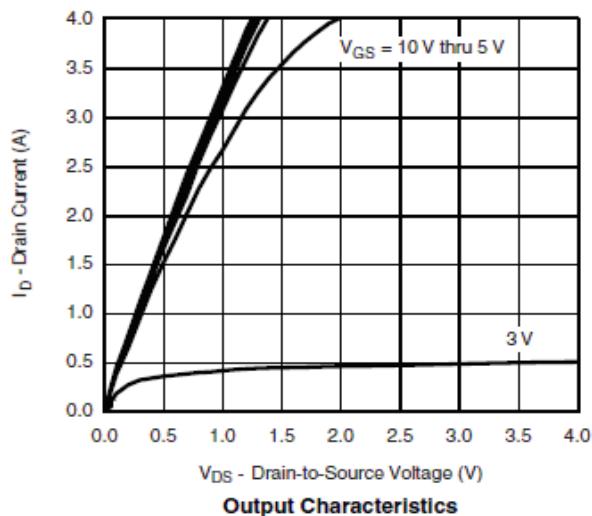
| Parameter                          | Symbol  | Condition                                      | Min.    | Typ. | Max. | Unit |
|------------------------------------|---------|--|---------|------|------|------|
| <b>STATIC PARAMETERS</b>           |         |  |         |      |      |      |
| Drain-source breakdown voltage     | BVdss   | Id=250µA, Vgs=0V                               | 150     |      |      | V    |
| Zero gate voltage drain current    | Idss    | Vds=100V                                       |         |      | 1    | µA   |
|                                    |         | Vgs=0V   | Ta=85°C |      | 10   |      |
| Gate-body leakage current          | Igss    | Vds=0V, Vgs=±20V                               |         |      | ±100 | nA   |
| Gate threshold voltage             | Vgs(th) | Vds=Vgs, Id=250µA                              | 1.0     | 1.8  | 2.5  | V    |
| On state drain current             | Id(on)  | Vgs=4.5V, Vds≥5V                               | 5       |      |      | A    |
| Static drain-source on-resistance  | Rds(on) | Vgs=10V, Id=1.5A                               |         | 280  | 350  | mΩ   |
|                                    |         | Vgs=4.5V, Id=1.0A                              |         | 320  | 400  |      |
| Forward transconductance           | Gfs     | Vds=15V, Id=1.5A                               |         | 4.1  |      | S    |
| Diode forward voltage              | Vsd     | Is=1.7A, Vgs=0V                                |         | 0.85 | 1.20 | V    |
| Max. body-diode continuous current | Is      |  |         |      | 4    | A    |
| <b>DYNAMIC PARAMETERS</b>          |         |  |         |      |      |      |
| Input capacitance                  | Ciss    | Vgs=0V, Vds=50V, f=1MHz                        |         | 400  |      | pF   |
| Output capacitance                 | Coss    |  |         | 20   |      | pF   |
| Reverse transfer capacitance       | Crss    |  |         | 15   |      | pF   |
| <b>SWITCHING PARAMETERS</b>        |         |  |         |      |      |      |
| Total gate charge                  | Qg      | Vgs=10V, Vds=75V<br>Id=1.5A                    |         | 5.5  | 10.0 | nC   |
| Gate-source charge                 | Qgs     |  |         | 1.2  |      | nC   |
| Gate-drain charge                  | Qgd     |  |         | 2.0  |      | nC   |
| Turn-on delay time                 | td(on)  | Vgs=10V, Vds=75V<br>RL=75Ω, Id=1.0A<br>Rgen=6Ω |         | 10   | 20   | ns   |
| Turn-on rise time                  | tr      |  |         | 10   | 20   | ns   |
| Turn-off delay time                | td(off) |  |         | 25   | 50   | ns   |
| Turn-off fall time                 | tf      |  |         | 15   | 30   | ns   |

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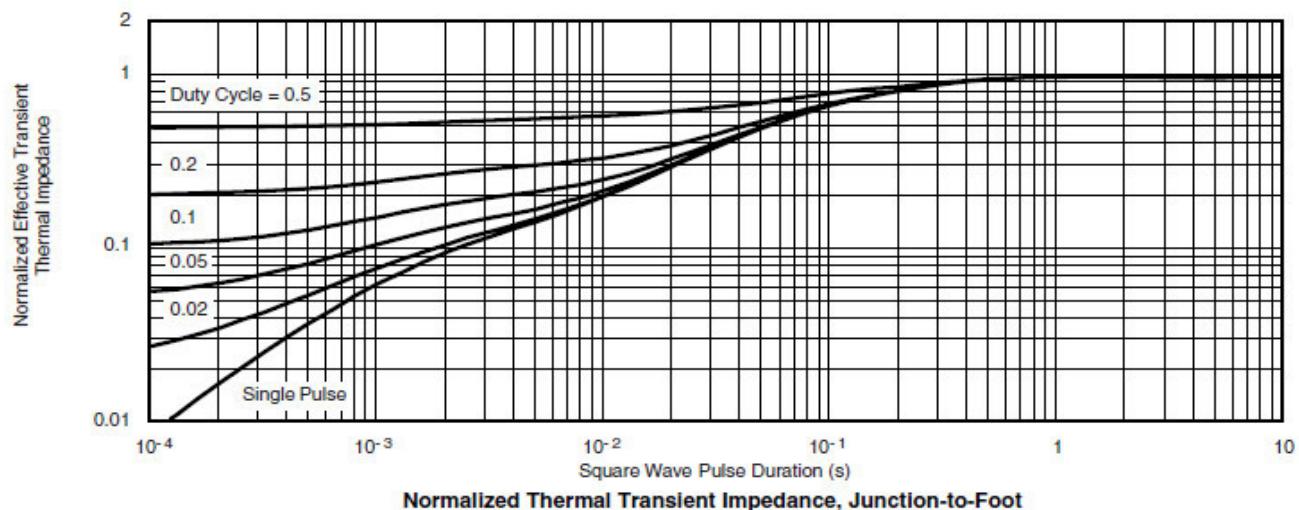
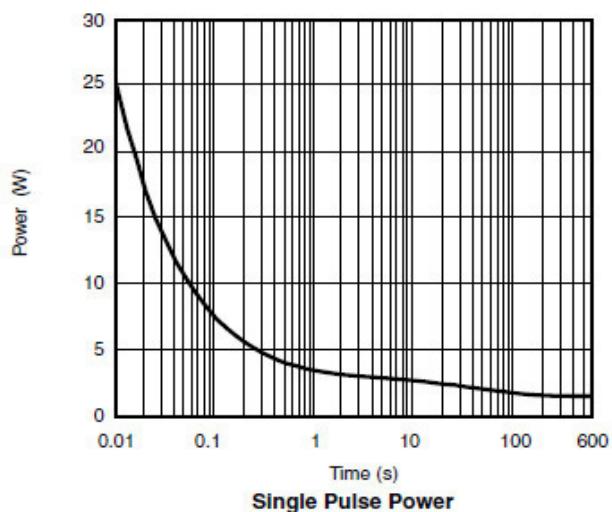
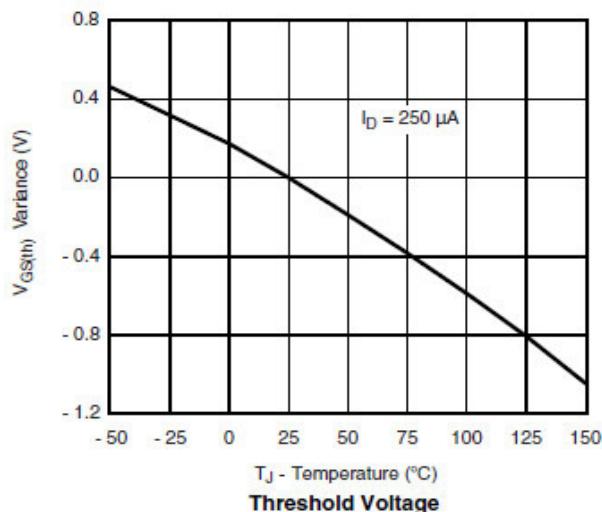
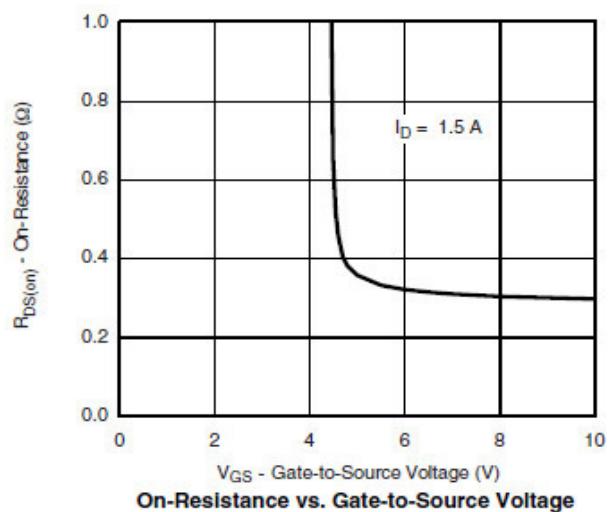
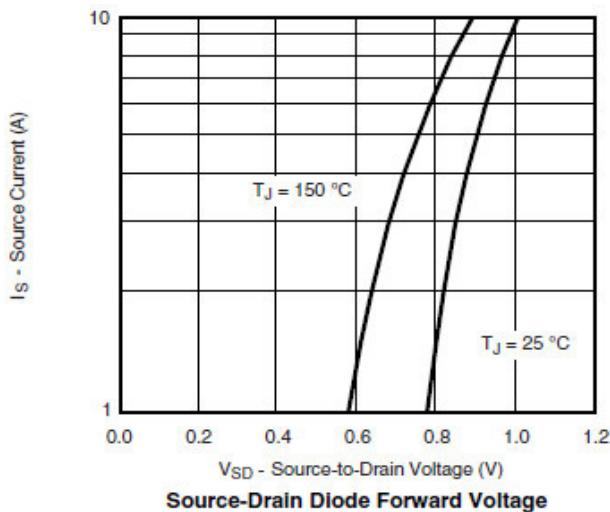
## ■ Typical electrical and thermal characteristics



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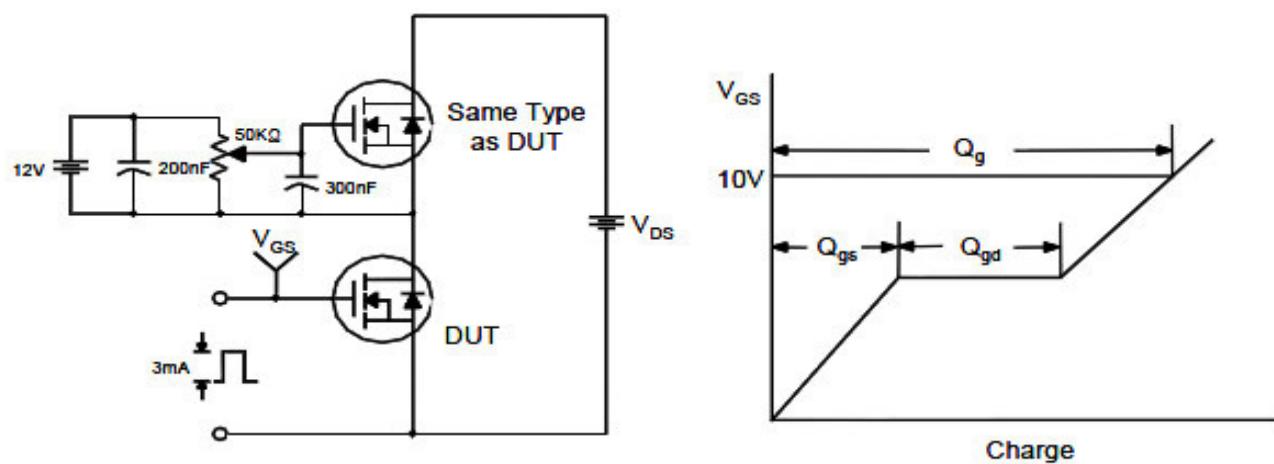
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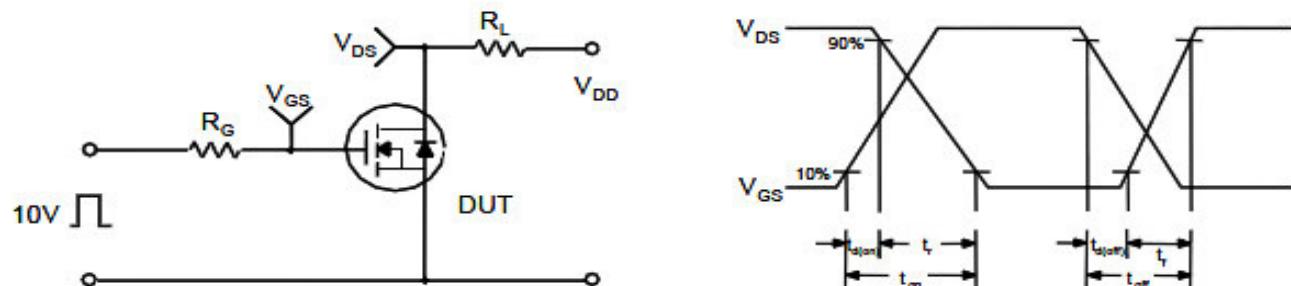
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## ■ Test circuit and waveform

Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

